# **CHIPQUIK®**

## NC2SWLF.020 0.3OZ

Datasheet revision 1.0 <u>www.chipquik.com</u>

### Solder Wire Sn99.3/Cu0.7 No-Clean with 2.0% Flux Core 0.3oz Tube

#### **Product Highlights**

No-Clean Synthetic Flux Core

The clear, non-corrosive, non-conductive residue is meant to be left on the board.

2.0% flux core

Halogen content: None

RoHS II and REACH compliant



Alloy: Sn99.3/Cu0.7
Wire Diameter: 0.020" (0.5mm)
Flux Type: No-Clean Synthetic

Flux Classification: ROL0

Melting Point: 227°C (441°F)
Packaging: 0.3oz Tube



#### **Test Results**

1 C3t NC3ult3		
Test J-STD-004 or other	Test Requirement	Result
requirements as stated		
Copper Mirror	IPC-TM-650: 2.3.32	L: No breakthrough
Corrosion	IPC-TM-650: 2.6.15	L: No corrosion
Quantitative Halides	IPC-TM-650: 2.3.28.1	L: <0.5%
Electrochemical Migration	IPC-TM-650: 2.6.14.1	L: <1 decade drop (No-clean)
Surface Insulation Resistance 85°C,	IPC-TM-650: 2.6.3.7	L: ≥100MΩ (No-clean)
85% RH @ 168 Hours		
Visual	IPC-TM-650: 3.4.2.5	Clear and free from precipitation
Conflict Minerals Compliance	Electronic Industry Citizenship	Compliant
	Coalition (EICC)	
REACH Compliance	Articles 33 and 67 of Regulation (EC) No 1907/2006	Contains no substance >0.1% w/w that is listed as a SVHC or restricted for use in solder materials

#### **Conforms to the following Industry Standards:**

J-STD-004B, Amendment 1 (Solder Fluxes):	Yes
J-STD-006C, Amendments 1 & 2 (Solder Alloys and Fluxed/Non-Fluxed Solders):	Yes
RoHS 2 Directive 2011/65/EU:	Yes